

IN THE SPECIFICATION:

Page 1, before line 3, the caption reading with "BACKGROUND OF THE INVENTION" insert the following title and paragraph:

-- PRIORITY CLAIM

B¹ This is a U.S. national stage of application No. PCT/FR98/00785, filed on April 17, 1998. Priority is claimed on that application and on the following application: France, Application No.: 97/05036, Filed: April 18, 1997 .

IN THE CLAIMS:

Please cancel claim 20.

Kindly amend the following claims as shown:

Subc¹ *B²* 15. A method of injection molding a receptacle fitted with a flat covering label having a thickness less than or equal to 80 microns, in which method the label is shaped in an unflattened configuration, wherein the label is shaped by sealing at least two edges together, the label being inserted into a mold prior to molding, the mold having a mold core, a mold matrix, and a molding space between the core and the matrix, the method comprising the successive steps of:

- i) gripping an outside face of the shaped label with movable pneumatic gripping means;
- ii) transferring and depositing the shaped label onto the core by the movable gripping means;
- iii) closing the mold; and
- iv) introducing plastics material in the molding space.

16. The method recited in claim 15, wherein the shaped label material has a thickness less than or equal to 50 microns.